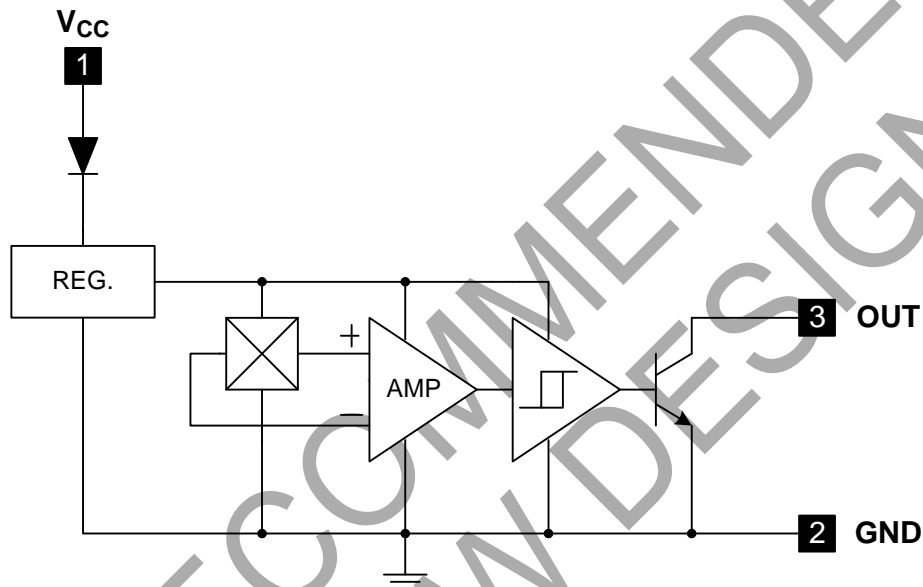


Pin Descriptions

Pin Name	Pin #	Description
V _{CC}	1	Positive Power Supply
GND	2	Ground
OUT	3	Output Stage

Functional Block Diagram



Absolute Maximum Ratings (T_A = +25°C)

Symbol	Characteristics	Values	Unit
V _{CC}	Supply Voltage	20	V
V _{OUT} (off)	Output "Off" Voltage	20	V
I _O (sink)	Output "On" Current	25	mA
T _S	Storage Temperature Range	-65 to +150	°C
T _J	Maximum Junction Temperature	+150	°C
P _D	Power Dissipation	SIP-3 (Ammo Pack)	550 mW
		SIP-3 (Bulk Pack)	550 mW
		SC59	230 mW

Recommended Operating Conditions

Symbol	Characteristic	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage	Operating	3.5	20	V
T _A	Operating Ambient Temperature (Note 4)	Operating	-40	+150	°C

Notes: 4. The device P_D and Safety Operation Area should not be exceeded.

Electrical Characteristics (T_A = +25°C)

Symbol	Characteristics	Conditions	Min	Typ.	Max	Unit
V _{OUT (SAT)}	Output Saturation Voltage	V _{CC} = 12V, OUT "ON" I _O = 10mA	-	300	400	mV
I _{CC}	Supply Current	V _{CC} = 12V, OUT "OFF"	-	3.5	6	mA

Magnetic Characteristics (T_A = +25°C, V_{CC} = 12V, unless otherwise specified, Note 5)

(1mT = 10 Gauss)

A Grade

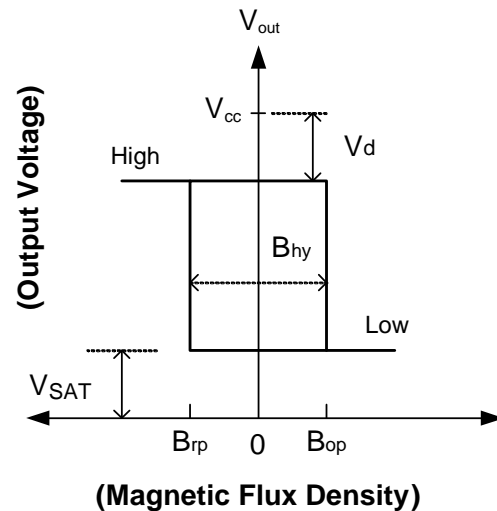
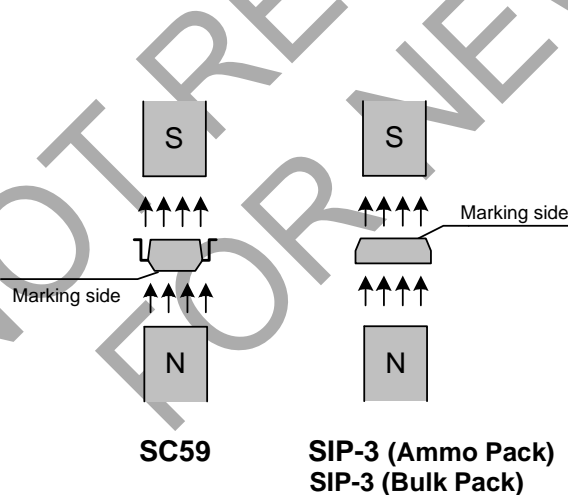
Symbol	Parameter	Min	Typ	Max	Unit
Bops(South Pole to Brand Side)	Operation Point	15	-	60	Gauss
Brps(South Pole to Brand Side)	Release Point	-60	-	-15	Gauss
Bhy(Bopx - Brpx)	Hysteresis	30	80	120	Gauss

B Grade

Symbol	Parameter	Min	Typ	Max	Unit
Bops(South Pole to Brand Side)	Operation Point	5	-	80	Gauss
Brps(South Pole to Brand Side)	Release Point	-80	-	-5	Gauss
Bhy(Bopx - Brpx)	Hysteresis	10	80	160	Gauss

Notes: 5. Magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

Operating Characteristics



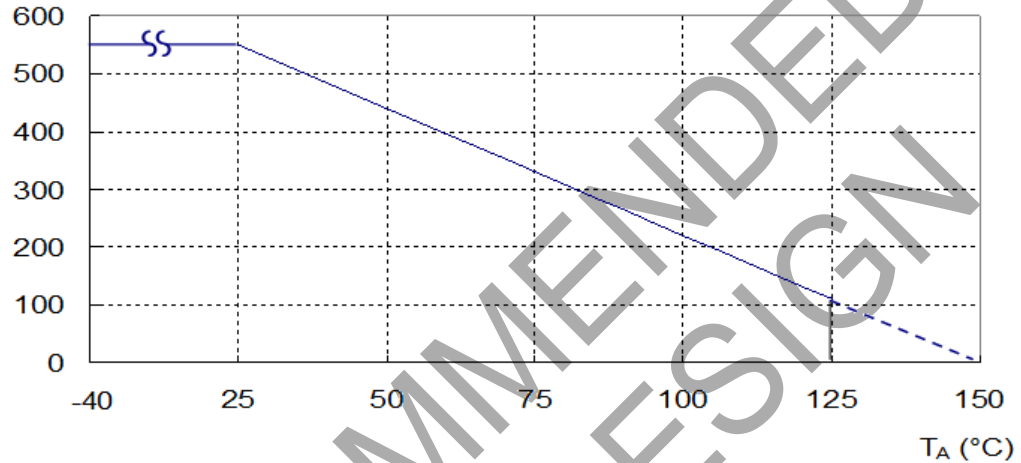
Performance Characteristics

(1) SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

T_A (°C)	25	50	60	70	80	85	90	95	100
P_D (mW)	550	440	396	352	308	286	264	242	220
T_A (°C)	105	110	115	120	125	130	135	140	150
P_D (mW)	198	176	154	132	110	88	66	44	0

 P_D (mW)

Power Dissipation Curve

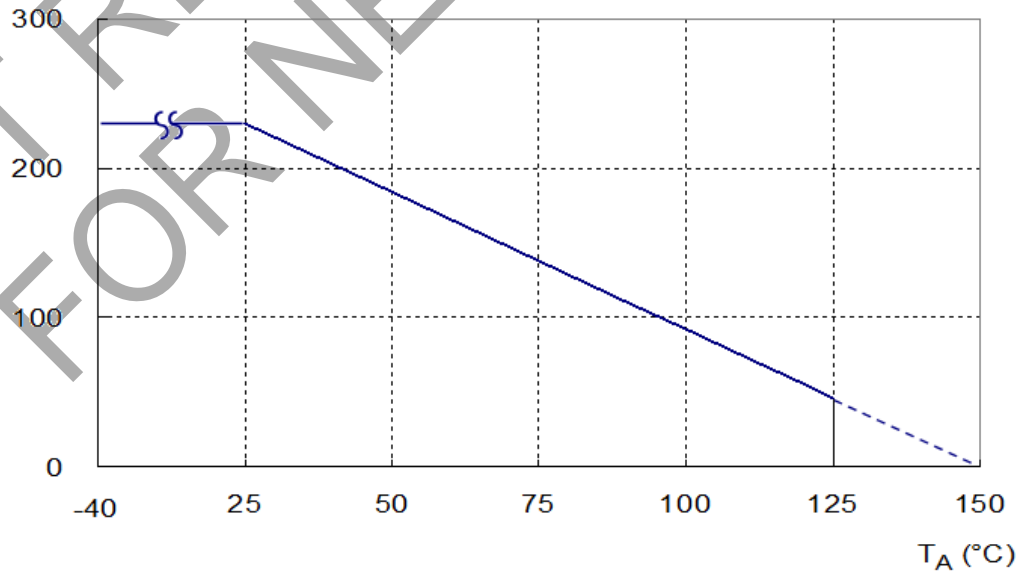


(2) SC59 (Commonly Known as SOT23 in Asia)

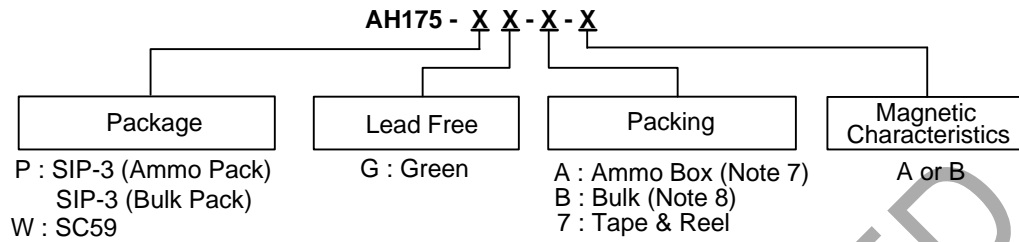
T_A (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P_D (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0

 P_D (mW)

Power Dissipation Curve



Ordering Information



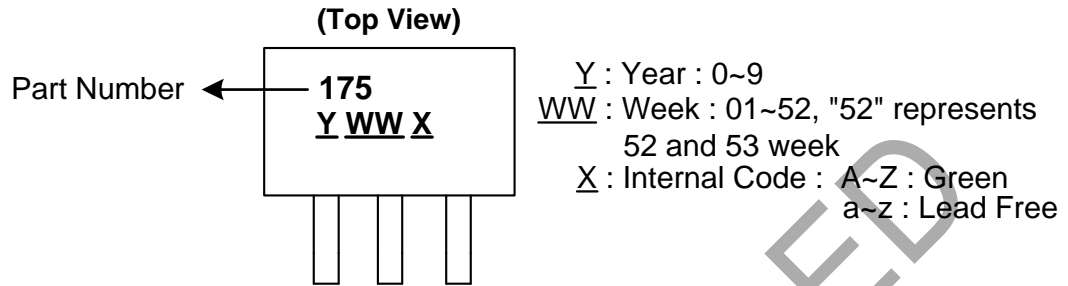
Part Number	Status (Note 9)	Package Code	Packaging (Note 6)	Bulk		7" Tape and Reel		Ammo Box	
				Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH175-PG-A-A	NRND	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH175-PG-A-B	NRND	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH175-PG-B-A	NRND	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH175-PG-B-B	NRND	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH175-WG-7-A	NRND	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA
AH175-WG-7-B	NRND	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA

Notes:

6. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
7. Ammo Box is for SIP-3 Spread Lead.
8. Bulk is for SIP-3 Straight Lead.
- 9: NRND = Not Recommended for New Design

Marking Information

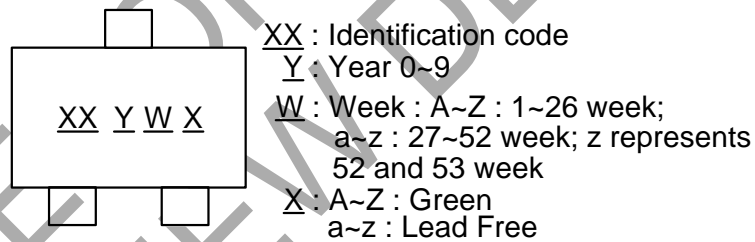
(1) SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)



Part Number	Package	Identification Code
AH175	SIP-3 (Ammo Pack)	175
AH175	SIP-3 (Bulk Pack)	175

(2) SC59 (Commonly Known as SOT23 in Asia)

(Top View)

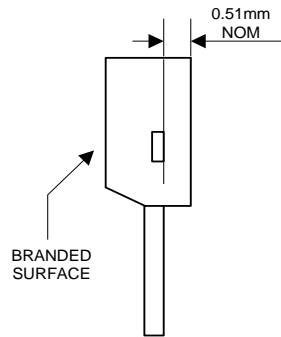


Part Number	Package	Identification Code
AH175	SC59	J5

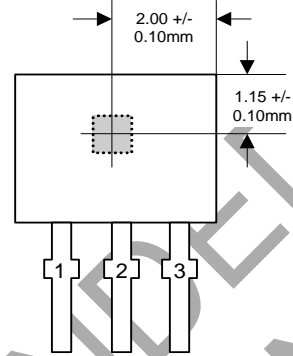
Package Outline Dimensions (All Dimensions in mm)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SIP-3 (Bulk Pack)

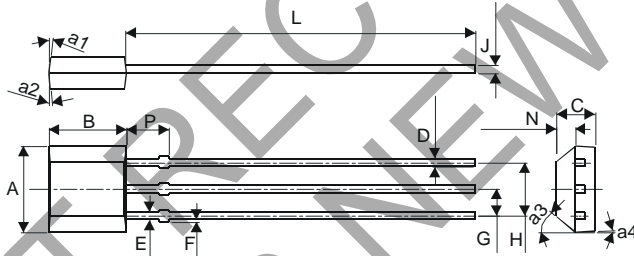


Active Area Depth



Sensor Location

Package Dimensions

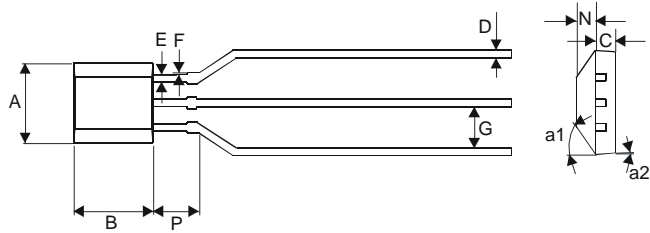


SIP-3 (Bulk Pack)		
Dim	Min	Max
A	3.9	4.3
a1	5° Typ	
a2	5° Typ	
a3	45° Typ	
a4	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.33	0.432
E	0.40	0.508
F	0	0.2
G	1.24	1.30
H	2.51	2.57
J	0.35	0.43
L	14.0	15.0
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

Package Outline Dimensions (Continued)

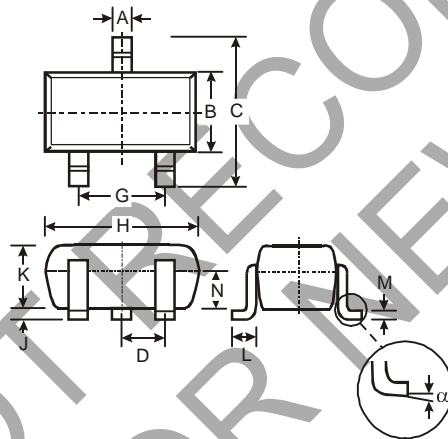
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(2) Package Type: SIP-3 (Ammo Pack)

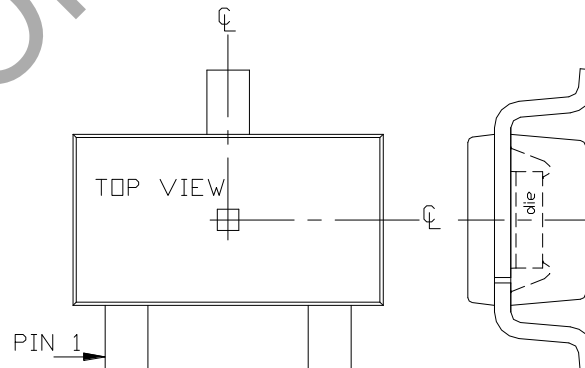


SIP-3 (Ammo Pack)		
Dim	Min	Max
A	3.9	4.3
a1	45° Typ	
a2	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.35	0.41
E	0.43	0.48
F	0	0.2
G	2.4	2.9
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

(3) SC59 (Commonly Known as SOT23 in Asia)



SC59			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	-
All Dimensions in mm			

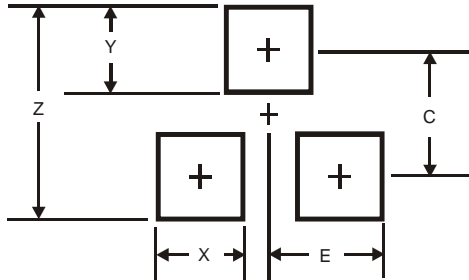


CL = Package Center Line

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59 (Commonly Known as SOT23 in Asia)



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1.0
C	2.4
E	1.35

NOT RECOMMENDED
FOR NEW DESIGN

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